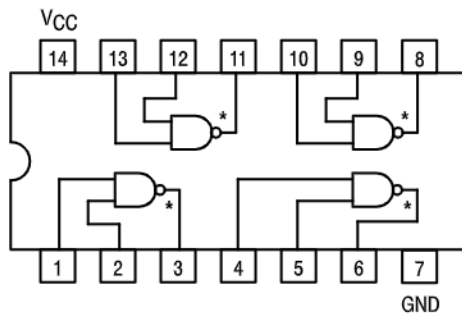




QUAD 2-INPUT NAND BUFFER

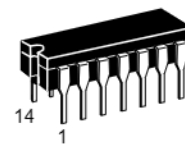
- ESD > 3500 Volts



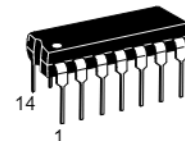
*OPEN COLLECTOR OUTPUTS

SN54/74LS26

QUAD 2-INPUT NAND BUFFER
LOW POWER SCHOTTKY



J SUFFIX
CERAMIC
CASE 632-08



N SUFFIX
PLASTIC
CASE 646-06



D SUFFIX
SOIC
CASE 751A-02

ORDERING INFORMATION

SN54LSXXJ	Ceramic
SN74LSXXN	Plastic
SN74LSXXD	SOIC

GUARANTEED OPERATING RANGES

Symbol	Parameter		Min	Typ	Max	Unit
V _{CC}	Supply Voltage	54 74	4.5 4.75	5.0 5.0	5.5 5.25	V
T _A	Operating Ambient Temperature Range	54 74	-55 0	25 25	125 70	°C
V _{OH}	Output Voltage — High	54, 74			15	V
I _{OL}	Output Current — Low	54 74			4.0 8.0	mA

SN54/74LS26

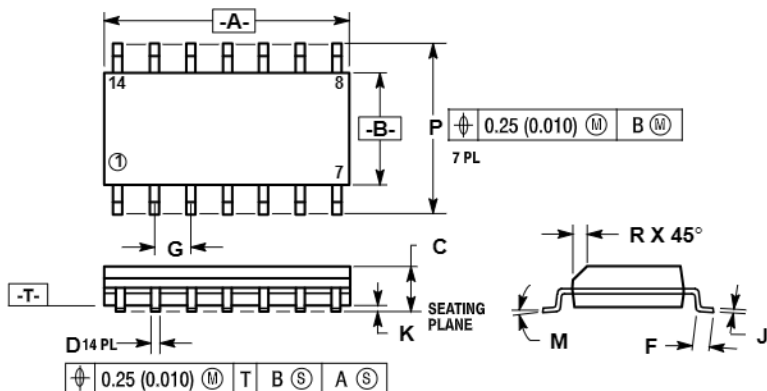
DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Symbol	Parameter		Limits			Unit	Test Conditions
			Min	Typ	Max		
V_{IH}	Input HIGH Voltage		2.0			V	Guaranteed Input HIGH Voltage for All Inputs
V_{IL}	Input LOW Voltage	54			0.7	V	Guaranteed Input LOW Voltage for All Inputs
		74			0.8		
V_{IK}	Input Clamp Diode Voltage			-0.65	-1.5	V	$V_{CC} = \text{MIN}$, $I_{IN} = -18 \text{ mA}$
I_{OH}	Output HIGH Current	54, 74			1000	μA	$V_{CC} = \text{MIN}$, $V_{OH} = \text{MAX}$
		54, 74			50	μA	$V_{CC} = \text{MIN}$, $V_{OH} = 12 \text{ V}$
V_{OL}	Output LOW Voltage	54, 74		0.25	0.4	V	$I_{OL} = 4.0 \text{ mA}$
		74		0.35	0.5	V	$I_{OL} = 8.0 \text{ mA}$
I_{IH}	Input HIGH Current				20	μA	$V_{CC} = \text{MAX}$, $V_{IN} = 2.7 \text{ V}$
					0.1	mA	$V_{CC} = \text{MAX}$, $V_{IN} = 7.0 \text{ V}$
I_{IL}	Input LOW Current				-0.4	mA	$V_{CC} = \text{MAX}$, $V_{IN} = 0.4 \text{ V}$
I_{CC}	Power Supply Current Total, Output HIGH				1.6	mA	$V_{CC} = \text{MAX}$
	Total, Output LOW				4.4		

AC CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

Symbol	Parameter		Limits			Unit	Test Conditions
			Min	Typ	Max		
t_{PLH}	Turn-Off Delay, Input to Output			17	32	ns	$V_{CC} = 5.0 \text{ V}$ $C_L = 15 \text{ pF}$, $R_L = 2.0 \text{ k}\Omega$
t_{PHL}	Turn-On Delay, Input to Output			15	28	ns	

Case 751A-02 D Suffix
14-Pin Plastic
SO-14

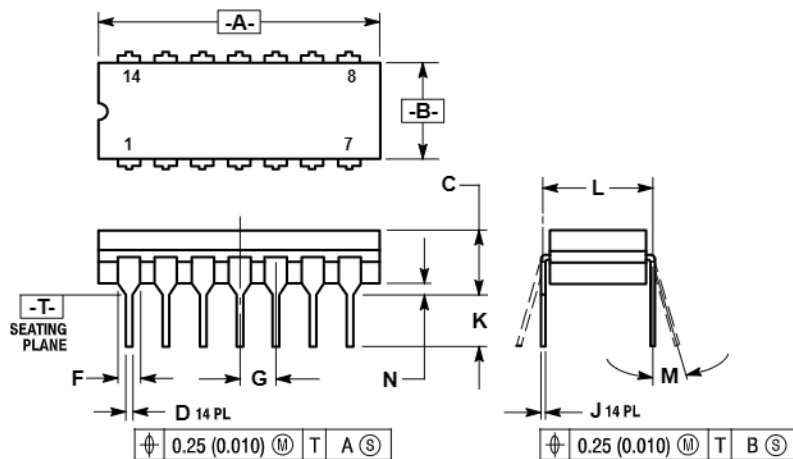


NOTES:

1. DIMENSIONS "A" AND "B" ARE DATUMS AND "T" IS A DATUM SURFACE.
2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
3. CONTROLLING DIMENSION: MILLIMETER.
4. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
5. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
6. 751A-01 IS OBSOLETE, NEW STANDARD 751A-02.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

Case 632-08 J Suffix
14-Pin Ceramic Dual In-Line

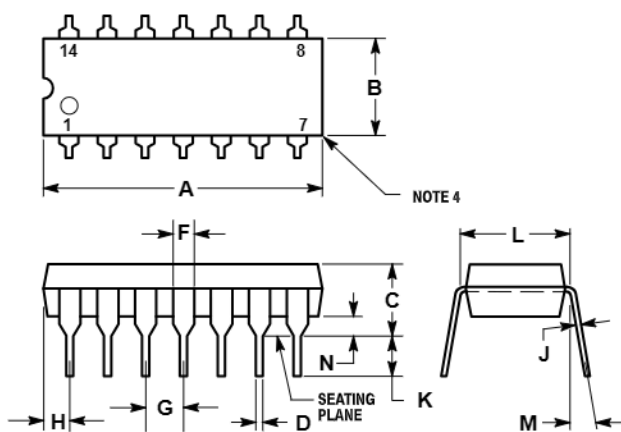


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIM F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.
5. 632-01 THRU -07 OBSOLETE, NEW STANDARD 632-08.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	19.05	19.94	0.750	0.785
B	6.23	7.11	0.245	0.280
C	3.94	5.08	0.155	0.200
D	0.39	0.50	0.015	0.020
F	1.40	1.65	0.055	0.065
G	2.54 BSC		0.100 BSC	
J	0.21	0.38	0.008	0.015
K	3.18	4.31	0.125	0.170
L	7.62 BSC		0.300 BSC	
M	0°	15°	0°	15°
N	0.51	1.01	0.020	0.040

Case 646-06 N Suffix
14-Pin Plastic



NOTES:

1. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
4. ROUNDED CORNERS OPTIONAL.
5. 646-05 OBSOLETE, NEW STANDARD 646-06.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	18.16	19.56	0.715	0.770
B	6.10	6.60	0.240	0.260
C	3.69	4.69	0.145	0.185
D	0.38	0.53	0.015	0.021
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	1.32	2.41	0.052	0.095
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	0°	10°	0°	10°
N	0.39	1.01	0.015	0.039

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